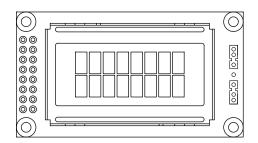
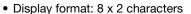
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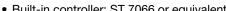
8 x 2 Character LCD



FEATURES

Type: Character





• Built-in controller: ST 7066 or equivalent COMPLIANT

• Duty cycle: 1/16

• 5 x 8 dots includes cursor

• + 5 V power supply

• LED can be driven by pin 1, pin 2, or A and K

• Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

MECHANICAL DATA									
ITEM	ITEM STANDARD VALUE								
Module Dimension	58.0 x 32.0 x 8.9 max.								
Viewing Area	38.0 x 16.0								
Dot Size	0.56 x 0.66	mm							
Dot Pitch	0.60 x 0.70	mm							
Mounting Hole	53.0 x 27.0								
Character Size	2.96 x 5.56								

ABSOLUTE MAXIMUM RATINGS											
ITEM	SYMBOL	STANDARD VALUE									
IIEW	STIVIDUL	MIN.	TYP.	MAX.	UNIT						
Power Supply	V_{DD} to V_{SS}	- 0.3	-	7.0	V						
Input Voltage	VI	V _{SS}	-	V_{DD}	V						

Note

• V_{SS} = 0 V, V_{DD} = 5.0 V

ELECTRICAL CHARACTE	ELECTRICAL CHARACTERISTICS												
ITEM	CVMDOL	CONDITION	ST	ANDARD VAL	.UE	UNIT							
IIEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNII							
Input Voltage	V_{DD}	V _{DD} = + 5 V	4.7	5.0	5.3	V							
Supply Current	I _{DD}	$V_{DD} = + 5 V$	1.0	1.2	1.5	mA							
		- 20 °C	-	-	5.5								
Recommended LC Driving		0 °C	-	-	-								
Voltage for Normal Temperature	V_{DD} to V_{0}	25 °C	-	4.4	-	V							
Version Module		50 °C	-	-	-								
		70 °C	3.5	-	-								
LED Forward Voltage	V _F	25 °C	-	4.2	4.6	V							
LED Forward Current	I _F	25 °C	-	70	140	mA							
EL Power Supply Current	I _{EL}	V _{EL} = 110 V _{AC} , 400 Hz	-	-	5.0	mA							

OPTIONS	OPTIONS											
	PROCESS COLOR BACKLIGHT											
TN	STN GRAY	STN YELLOW	STN BLUE	FSTN B&W	STN COLOR	NONE	LED	EL	CCFL			
х	Х	x	Х	Х	-	Х	Х	Х	ı			

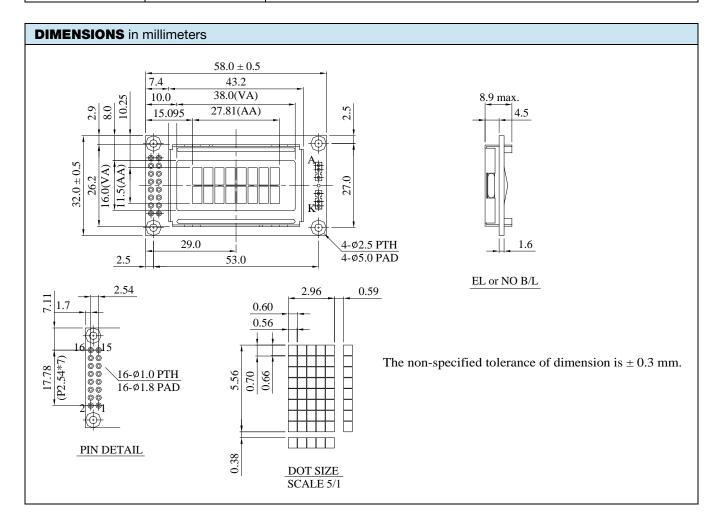
For detailed information, please see the "Product Numbering System" document.

DISPLAY CHARACTER ADDRESS CODE Display Position 2 3 4 5 6 8 **DD RAM Address** 00 01 02 03 04 05 07 06 **DD RAM Address** 40 41 42 43 44 45 46 47

Revision: 08-Jan-13 Document Number: 37470

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INTERFACE F	PIN FUNCTIONS	
PIN NO.	SYMBOL	FUNCTION
1	V _{SS}	Ground
2	V _{DD}	Supply voltage for logic + 5 V
3	V ₀	Operating voltage for LCD (variable)
4	RS	H: Data, L: Instruction code
5	R₩	H: Read (MPU \rightarrow module), L: Write (MPU \rightarrow module)
6	E	Chip enable signal
7	DB0	Data bus line
8	DB1	Data bus line
9	DB2	Data bus line
10	DB3	Data bus line
11	DB4	Data bus line
12	DB5	Data bus line
13	DB6	Data bus line
14	DB7	Data bus line
15	n/a	no connection
16	n/a	no connection



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1. Module Classification Information

LCD- 008 N 002 A1 -N F G -ET

1. Brand: Vishay Intertechnology, Inc.

2. Horizontal Format: 8 characters

3. Display Type : N→Character Type, H→Graphic Type

4. Vertical Format: 2 lines5. Model serials no.: A1

6. Backlight $N\rightarrow$ Without backlight $T\rightarrow$ LED, White Type: $B\rightarrow$ EL, Blue green $A\rightarrow$ LED, Amber $D\rightarrow$ EL, Green $R\rightarrow$ LED, Red $W\rightarrow$ EL, White $O\rightarrow$ LED, Orange

 $F\rightarrow CCFL$, White $G\rightarrow LED$, Green $Y\rightarrow LED$, Yellow Green

7. LCD Mode : B→TN Positive, Gray T→FSTN Negative

N→TN Negative, G→STN Positive, Gray

Y→STN Positive, Yellow Green

M→STN Negative, Blue

F→FSTN Positive

8. LCD Polarizer A \rightarrow Reflective, N.T, 6:00 H \rightarrow Transflective, W.T,6:00 Type/ Temperature D \rightarrow Reflective, N.T, 12:00 K \rightarrow Transflective, W.T,12:00 direction G \rightarrow Reflective, W. T, 6:00 C \rightarrow Transmissive, N.T,6:00 F \rightarrow Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

9. Special Code ET: English and European standard font;

Compliance with the ROHS Directions and regulations



2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)Supplier has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Supplier has the right to change the PCB Rev.

3. General Specification

Item	Dimension	Unit
Number of Characters	8 characters x 2 Lines	_
Module dimension	58.0 x 32.0 x 8.9 (MAX)	mm
View area	38.0 x 16.0	mm
Active area	27.81 x 11.5	mm
Dot size	0.56 x 0.66	mm
Dot pitch	0.60 x 0.70	mm
Character size	2.96 x 5.56	mm
Character pitch	3.55 x 5.94	mm
LCD type	FSTN Positive Reflective, (In LCD production, It will occur slightly color of can only guarantee the same color in the same by	
Duty	1/16	
View direction	6 o'clock	
Backlight Type	Without backlight	



4. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	$V_{\rm I}$	V_{SS}	_	V_{DD}	V
Supply Voltage For Logic	V_{DD} - V_{SS}	-0.3	_	7	V
Supply Voltage For LCD	$ m V_{DD} ext{-}V_0$	-0.3	_	13	V

5.Electrical Characteristics

Item Symbol		Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	5.5	V
Supply Voltage For LCD *Note	V_{DD} - V_0	Ta=25°C	_	4.4	_	V
Note		Ta=70°C	3.5	_	_	V
Input High Volt.	$V_{ m IH}$	_	$0.7~\mathrm{V_{DD}}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	V_{SS}	_	0.6	V
Output High Volt.	V_{OH}	_	3.9 –		V_{DD}	V
Output Low Volt.	V _{OL}	_	_	_	0.4	V
Supply Current	I_{DD}	V _{DD} =5V	1.0	1.2	1.5	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

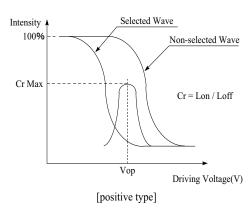


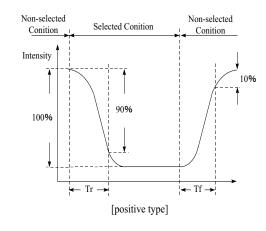
6.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit	
View Angle	(V) θ	CR≧2	30	_	60	deg	
, iew i mgie	(H) φ	CR≧2	-45	_	45	deg	
Contrast Ratio	CR	_	_	5	_	_	
Response Time @ 25C	T rise	_	_	150	200	ms	
200	T fall	_	_	150	200	ms	

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)



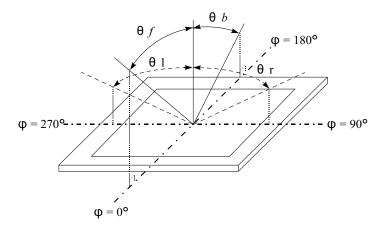


Conditions:

Operating Voltage: Vop Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle($CR \ge 2$)





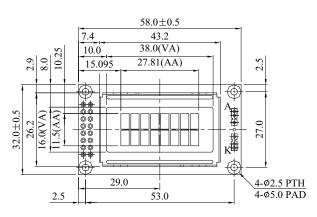
7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	V_{DD}	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	N/A		N/C
16	N/A		N/C

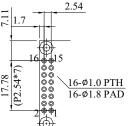
PIN NO. SYMBOL



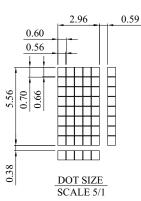
8.Contour Drawing & Block Diagram







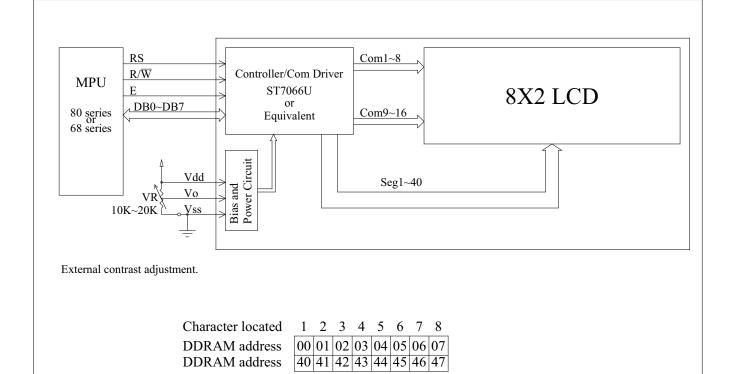
PIN DETAIL





The non-specified tolerance of dimension is ; A3 mm.

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9.Function Description

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

Busy Flag (BF)

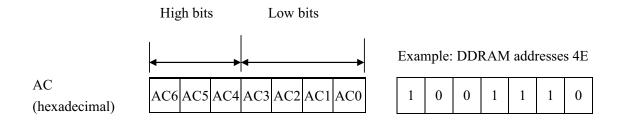
When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC)

The address counter (AC) assigns addresses to both DDRAM and CGRAM

Display Data RAM (DDRAM)

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80x8 bits or 80 characters. Below figure is the relationship between DDRAM addresses and positions on the liquid crystal display.



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Display position DDRAM address

1 2 3 4 5 6 7 8

00	01	02	03	04	05	06	07				
40	41	42	43	44	45	46	47				

2-Line by 8-Character Display

Character Generator ROM (CGROM)

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

Character Generator RAM (CGRAM)

In CGRAM, the user can rewrite character by program. For 5×8 dots, eight character patterns can be written, and for 5×10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.

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Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

Table 1.

For 5 * 8 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 1 0 1 0 0 1 1 0 0 1 0 0 1 1 1 1 1 1 0 0 0 0 0	* * * * * * * * * * * * * * * * * * *	Character pattern(1) Cursor pattern
0 0 0 0 * 0 0 1	0 0 1 0 1 0 0 1 1 0 1 1 0 0 1 1 1 0 0 1 1 0 1 1 1 0 0 0	* * * * * * * * * * * * * * * * * * *	Character pattern(2) Cursor pattern
0 0 0 0 * 1 1 1	1 1 1 1 0 0 1 0 1 1 1 0 1 1 1	* * *	

For 5 * 10 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0 High Low	5 4 3 2 1 0 High Low	7 6 5 4 3 2 1 0 High Low	
Tilgii Low	Iligii Low	~	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 0 1 0 0 0 0 0 1 1 0 0 0 0 1 1 1 1 1 1 1 0 0 0 0 1 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 0 0 0 1 0 0 0 0 1 0	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern Cursor pattern
	1 1 1 1	* * * * * * * *	

■ : " High "



10. Character Generator ROM Pattern

Table.2

Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH		СННН	HLLL	HLLH	HLHL	нгнн	HHLL	ннгн	нннг	нннн
LLLL	CG RAM (1)	[==	::: -			-:::[=	, " "			====
LLLH	CG RAM (2)	*****					-:::1	-:::[1,,.		:. :i.	-	.,!	** **	"1,1" 1	! .:
LLHL	CG RAM (3)		11	*****			ļi	Į-**	}::::		:::::		=[=[=			
LLHH	CG RAM (4)	# # # # # # # # # # # # # # # # # # #			 !,	-,,,:	====	-:::-	-:::	,". :"":		٠,		1111	! !!!	
LHLL	CG RAM (5)		-:[:-	:: <u> </u> -		*****	: <u>i</u>	··[.,				-	-15-1		***** *****	
LHLH	CG RAM (6)		****	!:::: !		!!	::::	I[-::::	*,		!		::::	1"	
LHHL	CG RAM (7)	***	="===			II	**!	11	-:::	.", !!			•.[
LHHH	CG RAM (8)			****			-::::	l,:,1	= ::::	*. !!		:-::	:::-	;**;	i.,	==
HLLL	CG RAM (1)		!	:::::			ļ.";	[:-:]		1,	.;[-"	****	-1,	1**** ****]-:]	
HLLH	CG RAM (2)		", 			==	71	1:::			i	-;"			.,,,	
HLHL	CG RAM (3)	.*.*	[**	.,.!"		-,.:	****		! !	.""."	"; ":"		*****	 ! .	
НГНН	CG RAM (4)]	::	-;- <u>-</u>		i	-=-		 	·";;	-:::"		1"1"1	1,.:	
HHLL	CG RAM (5)	****	#	***	<u> </u>	****	ii.			.""."					====	
ННГН	CG RAM (6)	1"1,1		****			l'i'i	"" ""	*.	****	.""." !""."!		11			****
НННГ	CG RAM (7)		11		!··!		!** !	***,*								
нннн	CG RAM (8)			****			i)	::::	****	* *****				1	:I'	



11.Instruction Table

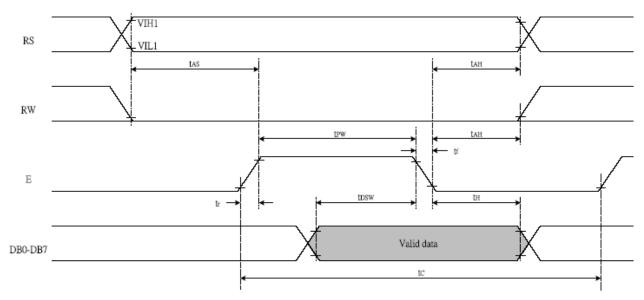
Instruction				Ins	structi	ion Co	de				5	Execution time
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(fuss=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53ms
Return Home	0	0	0	0	0	0	0	0	1	1	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	$39\mu\mathrm{s}$
Display ON/OFF Control	0	0	0	0	0	0	1	D	C	В	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	$39 \mu\mathrm{s}$
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	_	_	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μ s
Function Set	0	0	0	0	1	DL	N	F			Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5×8 dots)	39 μ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	$39\mu\mathrm{s}$
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 μ s

* "-": don't care



12.Timing Characteristics

12.1 Writing data from MPU to ST7066U

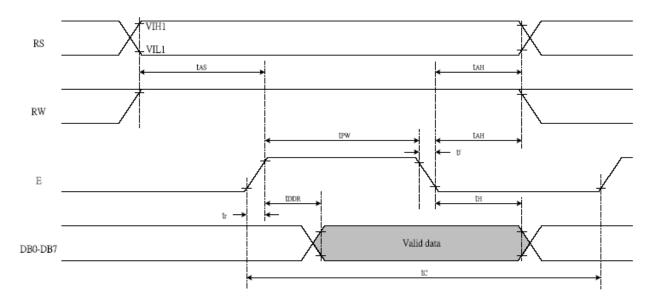


Ta=-30 \sim +85 $^{\circ}$ C, VDD=5.0 \pm 0.5V

TC	Enable Cycle Time	Pin E	1200	1	1	ns
TPW	Enable Pulse Width	Pin E	140	1	1	ns
TR,TF	Enable Rise/Fall Time	Pin E	-	1	25	ns
TAS	Address Setup Time	Pins: RS,RW,E	0	-	-	ns
TAH	Address Hold Time	Pins: RS,RW,E	10	-	-	ns
TDSW	Data Setup Time	Pins: DB0 - DB7	40	ı	1	ns
TH	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns



12.2Reading data from ST7066U to MPU



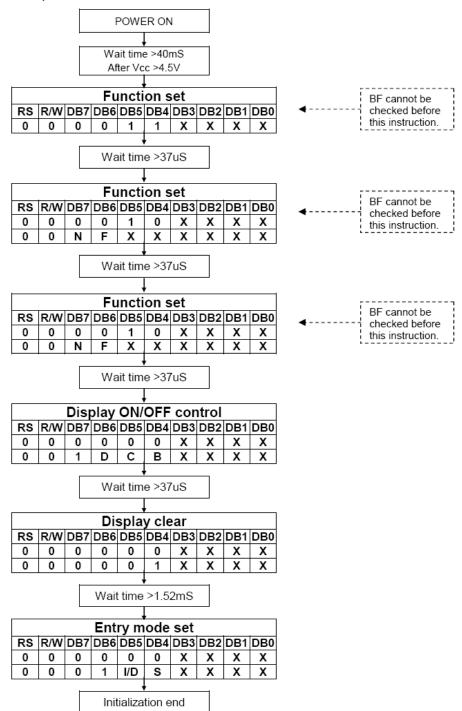
 $Ta=-30\sim+85^{\circ}C$, $VDD=5.0\pm0.5V$

Read Mode (Reading Data from ST7066U to MPU)						
TC	Enable Cycle Time	Pin E	1200	1	-	ns
TPW	Enable Pulse Width	Pin E	140	1	-	ns
TR,TF	Enable Rise/Fall Time	Pin E	-	-	25	ns
TAS	Address Setup Time	Pins: RS,RW,E	0	-	-	ns
TAH	Address Hold Time	Pins: RS,RW,E	10	-	-	ns
TDDR	Data Setup Time	Pins: DB0 - DB7	-	-	100	ns
TH	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns



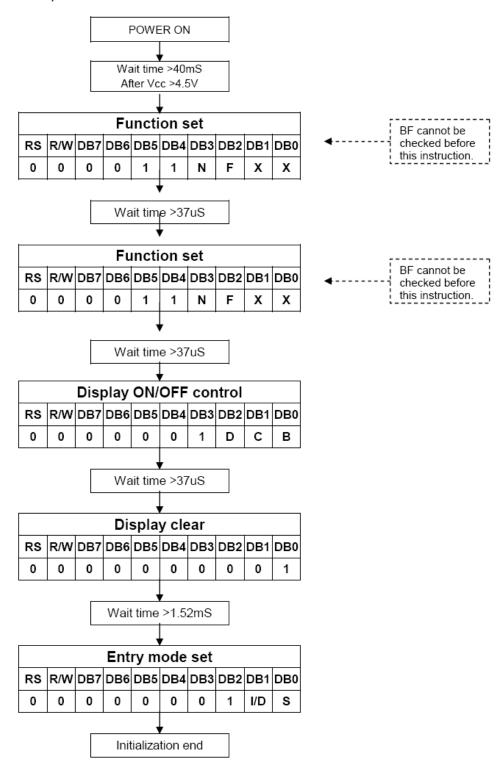
13.Initializing of LCM

4-bit Interface (fosc=270KHz)



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8-bit Interface (fosc=270KHz)





14. Reliability

Content of Reliability Test (wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°ℂ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	$\begin{array}{c} \text{VS=800V,RS=1.5k} \\ \Omega \\ \text{CS=100pF} \\ \text{1 time} \end{array}$	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.



15. Inspection specification

NO	Item			Criterion		AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 				0.65
02	Black or white spots on LCD (display only)	three white o	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 			
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type: $\Phi = (x + y) / X$ 3.2 Line type: (A)	Y As followin	SIZE $\Phi \leq 0.10$ $0.10 < \Phi \leq 0.20$ $0.20 < \Phi \leq 0.25$ $0.25 < \Phi$ and drawing) Width	1 0 Acceptable Q TY	2.5
		→ L H	L≦3.0 L≦2.5	$W \le 0.02 \\ 0.02 < W \le 0.03 \\ 0.03 < W \le 0.05$	Accept no dense	2.5
				0.05 < W	As round type	





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		If bubbles are visible, judge using black spot specifications, not easy	Size Φ $\Phi \leq 0.20$	Acceptable Q TY Accept no dense	
04	Polarizer L. c. 1	to find, must check in	$0.20 < \Phi \le 0.50$	3	2.5
			$0.50 < \Phi \le 1.00$	2	
			1.00 < Ф	0	
			Total Q TY	3	

NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	

2.5

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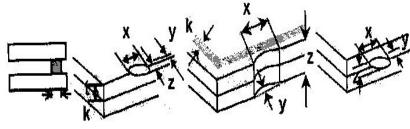
Symbols Define:

x: Chip ength y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length

L: Electrode pad length:

6.1 General glass chip:

6.1.1 Chip on panel surface and crack between panels:

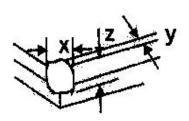


06 Chipped glass

z: Chip thickness	y: Chip width	x: Chip length
Z≦1/2t	Not over viewing area	x≤1/8a
$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a

⊙ If there are 2 or more chips, x is total length of each chip.

6.1.2 Corner crack:



z: Chip thickness	y: Chip width	x: Chip length
Z≦1/2t	Not over viewing area	x≤1/8a
$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a

⊙ If there are 2 or more chips, x is the total length of each chip.

NO	Item	Criterion	AQL

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2.5

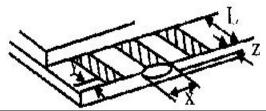


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Symbols:

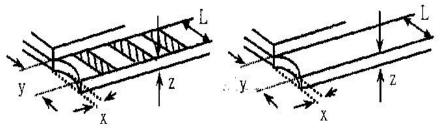
- x: Chip ength y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length
- L: Electrode pad length
- 6.2 Protrusion over terminal:
- 6.2.1 Chip on electrode pad:



y: Chip width	x: Chip length	z: Chip thickness
y ≤ 0.5mm	x≤1/8a	$0 < z \le t$

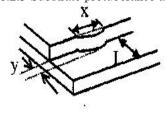
6.2.2 Non-conductive portion:

06 Glass crack



y: Chip width	x: Chip length	z: Chip thickness
y≦ L	x≤1/8a	$0 < z \le t$

- ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.
- ⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.
- 6.2.3 Substrate protuberance and internal crack.



y: width	x: length
y≤1/3L	$x \leq a$

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NO	Item	Item Criterion			
07	Cracked glass	The LCD with extensive crack is not acceptable.			
08	Backlight elements				
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.			
10	PCB · COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5 2.5		
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65		





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NO	Item	Criterion	AQL
NO 12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it causes the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging 	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65
		specification sheet. 12.11 Product dimension and structure must conform to product specification sheet.	0.65



16. Material List of Components for RoHS

1. Declaration that all of or part of products (with the mark "N" in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited	100	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.						

2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250°C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235°C ±5 degrees;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

17. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module



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